



LANGUAGE

ENGLISH

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		REVISE ON PC	ONLY	TITLE P	TITLE PRODUCT SPECIFICATION FOR EBBI							
	ADD SERIES 71661-7**** MIBARRA 3/1/2005 UCP2005-1735				50D PLUG AND RECEPTACLE CONNECTORS							
				THIS DOCUMENT CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INC. AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION								
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1.0 SCOPE

This specification covers the Molex EBBI 50D family of plug and receptacle connectors. This is an Economical Board to Board Interface system specific to the requirements set forth by Molex, Inc.

2.0 PRODUCT DESCRIPTION 2.1 CONNECTORS COVERED IN THIS SPECIFICATION

Description	Sales Drawing
Receptacle Connector, Vertical	SDA-71660-1***, -9***
Plug Connector, Vertical	SDA-71661-1***, -9***
Plug Connector, Right Angle	SDA-71661-2***
Plug Connector, SMT	SDA-71661-5***, -55**, -5910 SD-71661-001, -003, -004, -008, -009, -011 SD-74139-001, -002, -003, -004, -005, -006
Receptacle Connector, Blind Mate	SDA-71660-7***
Plug Connector, Blind Mate	SDA-71661-7***
Receptacle Connector, Vertical IDT	SDA-71660-3***

2.2 GENERAL DESCRIPTION

The Molex EBBI 50D interface is a cost effective, high density system. The connectors have a 0.050" (1.27 mm) contact centerline and use a "D" shaped mating face for polarization. Polarization on the blind mate connectors is achieved by two different size guiding posts. The products outlined here utilize a leaf system contact design that is duplex plated. This provides a gold plated interface for long-term reliability. The plug contact is fixed while the receptacle contact is compliant, allowing for variable mating depth.

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2.3 PRODUCT FAMILY

The EBBI 50D connector family consists of a vertical plug and receptacle, a right angle plug, a vertical SMT plug, and a vertical blind mate plug. These are available in select circuit sizes from 30 to 130. The receptacle connector can also serve as a card edge connector. All are designed to be wave soldered on a standard .062" thick printed circuit board (PCB) using conventional industry methods.

2.4 RIBBON CONNECTOR

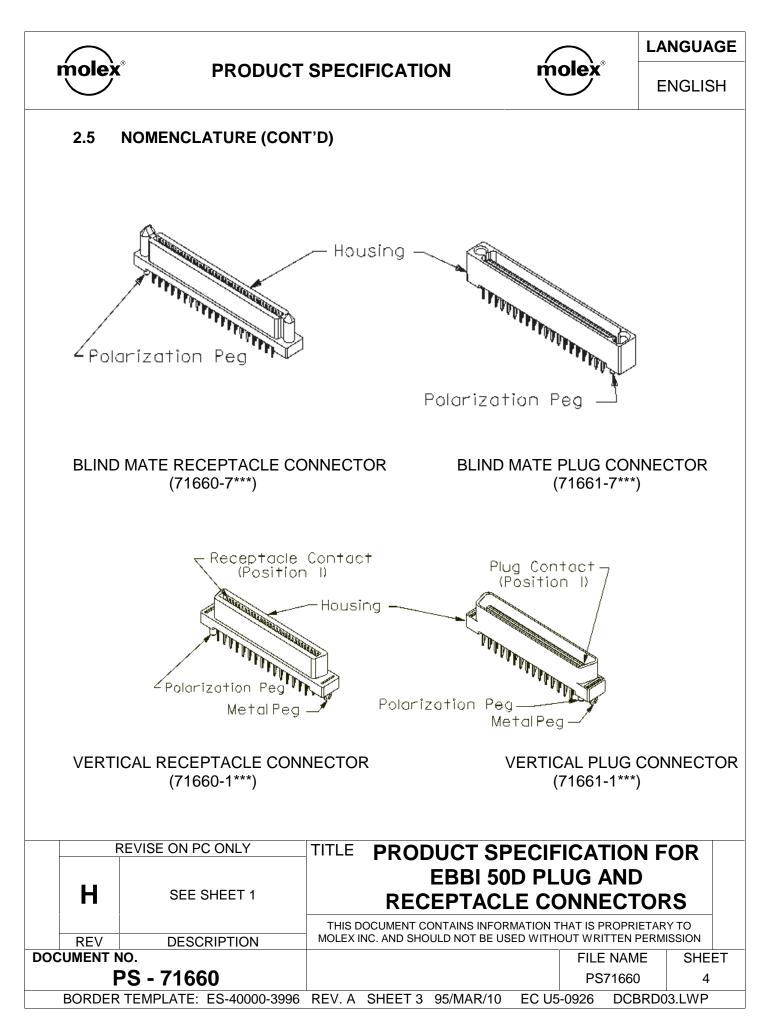
The vertical IDT receptacle connector mates with the Molex plug connector series 71661. The applicable wire range for this connector is stated below.

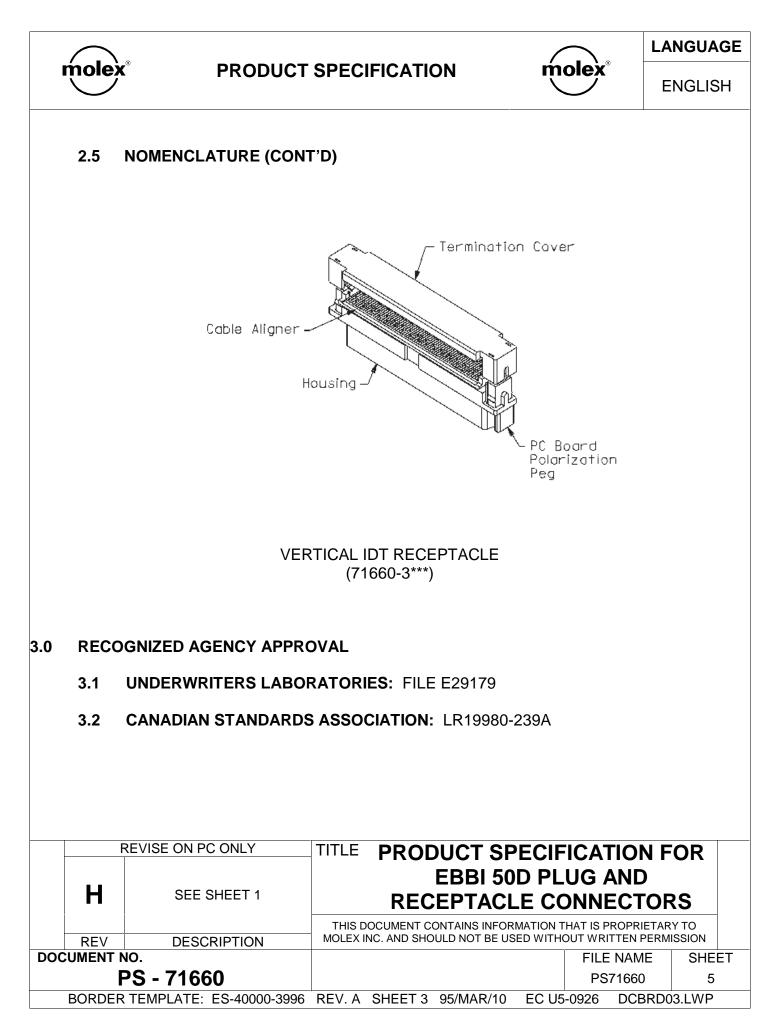
#30 AWG solid copper: Conductor O.D. to be 0.010° Insulation O.D. to be $.024^{\circ} \pm .002$ (PVC or TPR insulation)

#30 AWG stranded (7/38) tinned copper: Conductor O.D. to be 0.012". Insulation O.D. to be .024" $\pm .002$ (PVC or TPR insulation)

2.5 NOMENCLATURE

Tail Aligner Housing Plastic Peg RIGHT ANGLE PLUG CONNECTOR (71661-2***)			Н	ousing — Pola	(Po vertice) (Po v	ag		
		(71661-2***)			(7	71661-5	*** & 74139-5**	*)
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4.0 RATINGS

- 4.1 VOLTAGE: 30 VAC Maximum
- 4.2 CURRENT: 1.0 AMPS at 20°C maximum temperature rise
- 4.3 AMBIENT TEMPERATURE RANGE: -40°C to 105°C

5.0 ELECTRICAL PERFORMANCE

<u>TEST</u>	PROCEDURE	<u>CRITERIA</u>	<u>COMMENTS</u>
Contact Interface Resistance		10 m Ω delta	Mate connectors, measure by dry circuit, 20 mV max., 10 mA
Dielectric Strength	MIL-STD-202, Method 302, Condition B	No breakdown	Mate connectors, apply 500 VRMS for 1 minute between adjacent terminals of ground
Insulation Resistance	MIL-STD-202, Method 302, Condition B	100 mΩ, min.	Mate connectors, apply 500 VDC for 1 minute between adjacent terminals or ground
Current Cycling		20 °C maximum rise	45 minutes on, 15 minutes off for 240 hours
Temperature Rise, Steady State		20 °C maximum rise	DC current for 96 hours

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6.0 MECHANICAL PERFORMANCE

TEST	<u>CRITERIA</u>	<u>COMMENTS</u>			
Connector Mating and Unmating Forces	Mating forces: 90 gf x N max. (N=number of circuits) Unmating forces: 15 gf x N min. (N=number of circuits)	Mate and unmate connectors at a rate of 1.0 ± .12" (25 ± 3 mm) per minute			
Terminal Retention Force	1.00 lbs (0.45 kg) minimum	Apply axial pullout force at a rate of 1.0 ± .12" (25 ± 3 mm) per minute			
Cable Bend Strain Test (Vertical IDT only)	No breakage of core wires	Bend cable 45° from center in each direction while applying a 1 kg load to free end			

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7.0 ENVIRONMENTAL PERFORMANCE

<u>TEST</u>	PROCEDURE	<u>CRITERIA</u>	<u>COMMENTS</u>
Mate/Unmate Cycling	2000 Mate/Unmate cycles followed by thermal shock, thermal aging, and cyclic humidity	Mate/Unmate forces and Contact Resistance measured initially; measurements taken at 250 cycle intervals: $10 \text{ m}\Omega$ change from initial	Mate/unmate connectors for 2000 cycles at a rate of 10 cycles per minute
Thermal Aging	MIL-STD-202, Method 108A, Condition A	Appearance: No physical damage. Contact resistance: 10 mΩ change from initial.	Mated connectors subjected to 105 °C for 96 hours.
Vibration	MIL-STD-202, Method 201A	Appearance: No physical damage. Contact resistance: 10 mΩ change from initial Discontinuity: 1 msecond maximum.	Mated connectors to be soldered to a PCB with a simple harmonic motion along the X, Y and Z axes, having an amplitude of .059" (1.5 mm) P-P. Each axis shall be subjected to the entire range of 10-55- 10 Hz, traversed in one minute, Duration: 2 hours for each axis.
Mechanical Shock	MIL-STD-202 Method 213B, Condition A	Appearance:No physicaldamage.Contact resistance:10 mΩ change from initial.Discontinuity:1 msecondmaximum	Mated connectors to be soldered to a PCB with 50 grams of acceleration. 3 shocks along the X, Y and Z axes.
Thermal Shock		Appearance: No physical damage. Contact resistance: 10 mΩ change from initial	Mated connectors subjected to 105 °C to -40 °C with 30 minute dwell,
Steady State Humidity	MIL-STD-202 Method 103B, Condition B	Appearance: No physical damage. Contact resistance: 10 m Ω change from initial Insulation Resistance: 100 m Ω min. Must pass dielectric strength	Mated connectors subjected to 60± 2 °C at 90-95% RH for 96 hours.

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7.0 ENVIRONMENTAL PERFORMANCE (CONTINUED)

<u>TEST</u>	PROCEDURE	<u>CRITERIA</u>	<u>COMMENTS</u>		
Cyclic Humidity	MIL-STD-202 Method 106D	Appearance: No physical damage. Contact resistance: 10 m Ω change from initial Insulation Resistance: 100 m Ω min. Must pass dielectric strength	Mated connectors subjected to 25°C - 65 °C at 90-95% RH for 240 hours		
Mixed Flowing Gas Test	Battelle Class II	Appearance: No physical damage Contact resistance: $10 \text{ m}\Omega$ change from initial	Subject mated connector to a mixed gas for 10 days at 30° C. Linear flow rate to be 305 mm/second.		
Solderability		95% of immersed area must show no voids or pin holes.	Test Parameters: Soldering time to be 3 ± 0.5 seconds. Solder temperature to be 230 ± 5 °C		

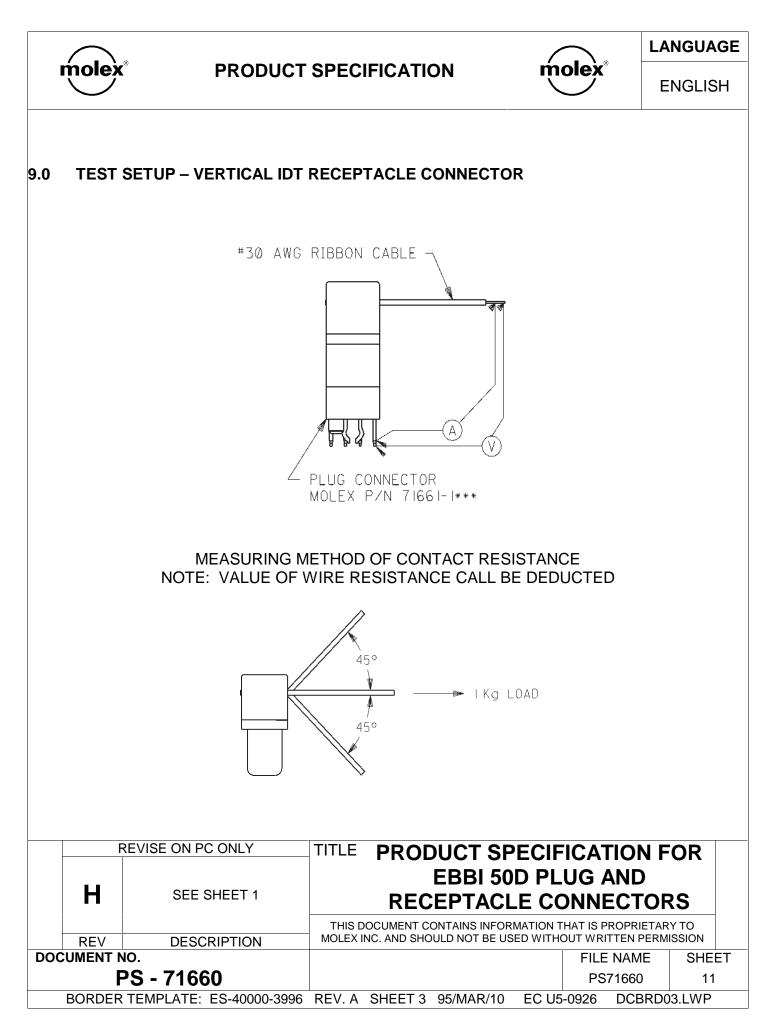
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8.0 TEST SEQUENCE

TEST OR		TEST SEQUENCE									
EXAMINATION	1	2	3	4	5	6	7	8*			
EXAMINATION OF PRODUCT	1	1	1	1	1	1	1	1			
MEASURE CONTACT RESISTANCE	2,4,6,8	2,4,6,8,10	2,4,6,8	2,4,6,8,10			2,4,6	2,4,6,8			
MEASURE TEMPERATURE					2,4,6,8,10	2,4,6,8,10,12					
THERMAL SHOCK	3	5									
MATE/UNMATE CYCLING		3		3		3					
THERMAL AGING	5	7									
CYCLIC HUMIDITY	7	9									
STEADY STATE HUMIDITY			3	5	3	5					
MIXED FLOWING GAS							3	3			
VIBRATION			7	9				7			
MECHANICAL SHOCK			5	7							
CURRENT CYCLING					7	9					
TEMPERATURE RISE- STEADY STATE					5,9	7,11					
MATE/UNMATE							F				
CYCLING CABLE BEND (VERTICAL IDT ONLY)							5	5			
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PROCESSI STEP	<u>NG</u>	RECOMMEND/	<u>COMMENTS</u>		
Picking and Pla SMT Plug Connectors usi the Pick and Pl Caps/Clips	ng <u>Circuit Size</u>	Acceleration L Vertical Move 39.5 32.4 27.5 24.0 21.6 18.9 15.7	<u>imits (in ft/sec²)</u> <u>Horizontal Move</u> 49.7 40.8 34.6 30.2 27.1 23.7 19.7	These limits prevent the Connector from moving in relationship to the vacuum cap/clip during the transfer from the connector packaging to the printed circuit board.	
Resistance to Soldering Heat	Maximum time be 40 seconds Note: 71661-2	2***; 71661-5*** and Ir @100°C prior to p	Appearance: No physical damage.		
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